

PCBA Cleanliness Guidelines

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Best Practices: Control & Measure

- Confirm incoming board cleanliness
- Clean before solder mask application
- Clean after soldering operations
- Then measure:
 - Water quality going into process
 - Assembly cleanliness with ionograph

PCBA Cleanliness: Overview

- Ensuring the cleanliness of printed circuit board assemblies involves process and control
- Process
 - Cleaning must be introduced at the appropriate locations within the manufacturing process
- Control
 - The effectiveness of the cleaning processes must be validated through monitoring and measurement

Printed Circuit Board Cleanliness

- The cleanliness of printed circuit boards (PCBs) has become especially critical in recent years due to
 - ❑ Decreasing conductor spacings (increased risk of electrochemical migration)
 - ❑ Increased use of no-clean flux (the last cleaning operations are PCB fabrication)
 - ❑ Movement of PCB fabrication to low cost countries

PCB Cleaning Process (Location)

- At a minimum, PCB manufacturers should clean the PCB
 - Immediately before the application of solder resist
 - Immediately after the application of any solderability plating
 - HASL
 - Electroless Nickel and Immersion Gold
 - Immersion Tin
 - Immersion Silver
- Some PCB manufacturers also perform a final clean
 - Should not substitute cleaning after solderability plating
 - Residues from plating operations can become more difficult to remove with any time delay

PCB Cleaning Process (Requirements)

- Final rinse with deionized (DI) water
 - 18 MΩ is preferred
 - Distilled water is insufficient
 - 'City' water is unacceptable
- Potential options
 - Use of saponifier during the cleaning process
 - Heated DI water is nice, but not absolutely necessary
- Common problems
 - DI water is only used if specified by the customer
 - DI water is turned off to reduce water and energy usage
 - Failure to monitor DI water at the source
 - Failure to alarm the DI water on the manufacturing floor

PCB Cleanliness Control: Industry Specs

- IPC-6012B, Qualification and Performance Specification for Rigid Printed Boards, Section 3.9
 - Requires confirmation of board cleanliness before solder resist application
 - When specified, requires confirmation of board cleanliness after solder resist or solderability plating
- Board cleanliness before solder resist shall not be greater than 10 ug/in² of NaCl equivalent (total ionics)
 - Based on military specifications from >30 years ago
- Board cleanliness after solder resist shall meet the requirements specified by the customer

PCB Cleanliness Control (Test Procedures)

- IPC-6012B specifies a Resistance of Solvent Extract (ROSE) method
 - Defined by IPC-TM-650 2.3.25
- IPC-6012B specifies this measurement should be performed on production boards every lot
 - Class 1 boards: Sampling Plan 6.5
 - Class 2 and 3 boards: Sample Plan 4.0
- Sampling plan (example)
 - If a lot contains 500 panels of a Class 2 product, 11 panels should be subjected to ROSE measurements for cleanliness testing

This is only 1/3rd of the entire presentation. Interested? Want more?

Please contact us by email (askdfr@dfrsolutions.com) or phone (301-474-0607) for more information

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*Best Regards,
Dr. Craig Hillman, CEO*